8-input multiplexer Rev. 2 — 11 February 2013

Product data sheet

1. General description

The 74HC151-Q100; 74HCT151-Q100 are 8-bit multiplexer with eight binary inputs (I0 to I7), three select inputs (S0 to S2) and an enable input (\overline{E}). One of the eight binary inputs is selected by the select inputs and routed to the complementary outputs (Y and \overline{Y}). A HIGH on \overline{E} forces the output Y LOW and output \overline{Y} HIGH. Inputs also include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Input levels:
 - For 74HC151-Q100: CMOS level
 - For 74HCT151-Q100: TTL level
- Low-power dissipation
- Non-inverting data path
- Specified in compliance with JEDEC standard no. 7A
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options

3. Ordering information

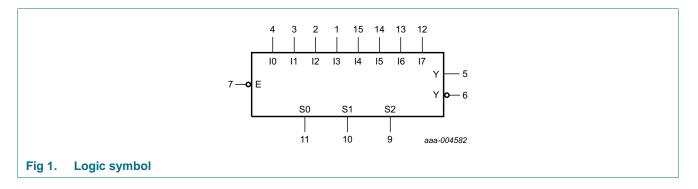
Table 1.Ordering information

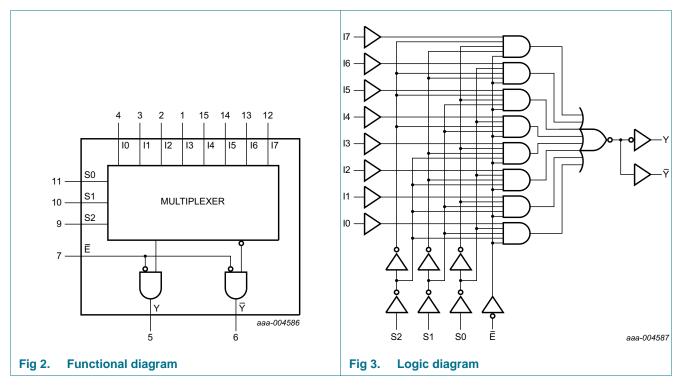
Type number	Package									
	Temperature range	Name	Description	Version						
74HC151D-Q100	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width	SOT109-1						
74HCT151D-Q100			3.9 mm							
74HC151PW-Q100	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads;	SOT403-1						
74HCT151PW-Q100			body width 4.4 mm							



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4. Functional diagram

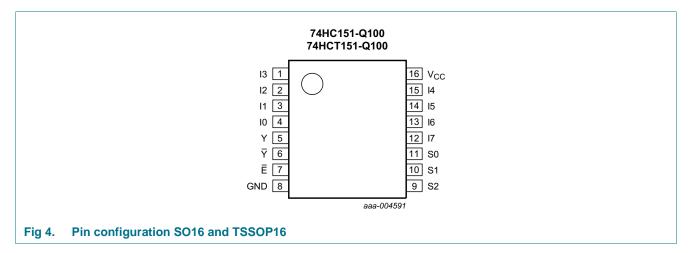




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Pinning information 5.

5.1 Pinning



5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
10 to 17	4, 3, 2, 1, 15, 14, 13, 12	data inputs
Y	5	multiplexer output
Y	6	complementary multiplexer output
Ē	7	enable input (active LOW)
GND	8	ground (0 V)
S0, S1, S2	2 11, 10, 9	common data select inputs
V _{CC}	16	supply voltage

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6. Functional description

Table 3. Function table^[1]

Input												Outp	ut
E	S2	S1	S0	10	I 1	12	13	14	15	16	17	Y	Y
Н	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Н	L
L	L	L	L	L	Х	Х	Х	Х	Х	Х	Х	Н	L
L	L	L	L	Н	Х	Х	Х	Х	Х	Х	Х	L	Н
L	L	L	Н	Х	L	Х	Х	Х	Х	Х	Х	Н	L
L	L	L	Н	Х	Н	Х	Х	Х	Х	Х	Х	L	Н
L	L	Н	L	Х	Х	L	Х	Х	Х	Х	Х	Н	L
L	L	Н	L	Х	Х	Н	Х	Х	Х	Х	Х	L	Н
L	L	Н	Н	Х	Х	Х	L	Х	Х	Х	Х	Н	L
L	L	Н	Н	Х	Х	Х	Н	Х	Х	Х	Х	L	Н
L	Н	L	L	Х	Х	Х	Х	L	Х	Х	Х	Н	L
L	Н	L	L	Х	Х	Х	Х	Н	Х	Х	Х	L	Н
L	Н	L	Н	Х	Х	Х	Х	Х	L	Х	Х	Н	L
L	Н	L	Н	Х	Х	Х	Х	Х	Н	Х	Х	L	Н
L	Н	Н	L	Х	Х	Х	Х	Х	Х	L	Х	Н	L
L	Н	Н	L	Х	Х	Х	Х	Х	Х	Н	Х	L	Н
L	Н	Н	Н	Х	Х	Х	Х	Х	Х	Х	L	Н	L
L	Н	Н	Н	Х	Х	Х	Х	Х	Х	Х	Н	L	Н

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

				10	,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	$V_{\rm I}$ < –0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	-	±20	mA
Ι _{ΟΚ}	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	-	±20	mA
I _O	output current	$V_{O} = -0.5 \text{ V to} (V_{CC} + 0.5 \text{ V})$	-	±25	mA
I _{CC}	supply current		-	+50	mA
I _{GND}	ground current		-	-50	mA
T _{stg}	storage temperature		-65	+150	°C

Table 4. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \text{ to } +125 \ ^{\circ}C$			
	SO16 package		<u>[1]</u> _	500	mW
	TSSOP16 package		[2] _	500	mW

[1] For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 $^\circ C.$

[2] For TSSOP16 package: Ptot derates linearly with 5.5 mW/K above 60 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC151-Q100			74HCT	0	Unit	
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V_{CC}	0	-	V_{CC}	V
Vo	output voltage		0	-	V_{CC}	0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

74HC_HCT151_Q100

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9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Ta	_{mb} = 25	°C		40 °C to 5 °C	T _{amb} = −40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC15	1-Q100			•						
VIH	HIGH-level	$V_{CC} = 2.0 V$	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	$V_{CC} = 4.5 V$	3.15	2.4	-	3.15	-	3.15	-	V
		$V_{CC} = 6.0 V$	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	$V_{CC} = 2.0 V$	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	$V_{CC} = 4.5 V$	-	2.1	1.35	-	1.35	-	1.35	V
		$V_{CC} = 6.0 V$	-	2.8	1.8	-	1.8	-	1.8	V
V _{ОН}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O} = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_O = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		I_{O} = -5.2 mA; V_{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 20 \ \mu A; V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		I_{O} = 4.0 mA; V_{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		$I_0 = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	-	±1.0	-	±1.0	μA
СС	supply current		-	-	8.0	-	80	-	160	μA
CI	input capacitance		-	3.5	-					pF

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Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Ta	_{mb} = 25	°C		40 °C to 5 °C		-40 °C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HCT1	51-Q100					1	1		1	
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		$I_0 = -4 \text{ mA}$	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = 20 μA	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V
lı	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} \text{ or } GND; \ I_{O} = 0 \ A; \\ V_{CC} = 5.5 \ V \end{array}$	-	-	8.0	-	80	-	160	μA
∆l _{CC}	additional supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} - 2.1 \text{ V};\\ \text{other inputs at } V_{CC} \text{ or GND};\\ V_{CC} = 4.5 \text{ V to 5.5 V};\\ I_{O} = 0 \text{ A} \end{array}$								
		per input pin; In inputs	-	45	162	-	203	-	221	μΑ
		per input pin; \overline{E} input	-	30	108	-	135	-	147	μΑ
		per input pin; Sn input	-	150	540	-	675	-	735	μΑ
CI	input capacitance		-	3.5	-					pF

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10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 7.

Symbol	Parameter	Conditions	T _{ar}	_{nb} = 25	°C		= –40 °C ⋅85 °C	T _{amb} = −40 °C to +125 °C		Unit	
				Min	Тур	Max	Min	Мах	Min	Max	
74HC15	1-Q100										
t _{pd}	propagation	In to Y; see Figure 5	[1]								
	delay	$V_{CC} = 2.0 V$		-	52	170	-	215	-	255	ns
		$V_{CC} = 4.5 V$		-	19	34	-	43	-	51	ns
		V _{CC} = 5 V; C _L = 15 pF		-	17	-	-	-	-	-	ns
		$V_{CC} = 6.0 V$		-	15	29	-	37	-	43	ns
		In to \overline{Y} ; see Figure 5	[1]								
		$V_{CC} = 2.0 V$		-	58	185	-	230	-	280	ns
		$V_{CC} = 4.5 V$		-	21	37	-	46	-	56	ns
		V _{CC} = 5 V; C _L = 15 pF		-	17	-	-	-	-	-	ns
		$V_{CC} = 6.0 V$		-	17	31	-	39	-	48	ns
		Sn to Y; see Figure 6	[1]								
		$V_{CC} = 2.0 V$		-	61	185	-	230	-	280	ns
		$V_{CC} = 4.5 V$		-	22	37	-	46	-	56	ns
		V _{CC} = 5 V; C _L = 15 pF		-	19	-	-	-	-	-	ns
		$V_{CC} = 6.0 V$		-	18	31	-	39	-	48	ns
		Sn to \overline{Y} ; see Figure 6	[1]								
		$V_{CC} = 2.0 V$		-	61	205	-	255	-	310	ns
		$V_{CC} = 4.5 V$		-	22	41	-	51	-	62	ns
		V _{CC} = 5 V; C _L = 15 pF		-	19	-	-	-	-	-	ns
		$V_{CC} = 6.0 V$		-	18	35	-	43	-	53	ns
		E to Y; see Figure 6									
		$V_{CC} = 2.0 V$		-	41	125	-	155	-	190	ns
		$V_{CC} = 4.5 V$		-	15	25	-	31	-	38	ns
		V _{CC} = 5 V; C _L = 15 pF		-	12	-	-	-	-	-	ns
		$V_{CC} = 6.0 V$		-	12	21	-	26	-	32	ns
		\overline{E} to \overline{Y} ; see Figure 6									
		$V_{CC} = 2.0 V$		-	47	145	-	180	-	220	ns
		$V_{CC} = 4.5 V$		-	17	29	-	36	-	44	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	14	-	-	-	-	-	ns
		$V_{CC} = 6.0 V$		-	14	25	-	31	-	38	ns
t _t	transition	Y, Y; see <u>Figure 5</u>	[2]								
	time	$V_{CC} = 2.0 V$		-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V		-	7	15	-	19	-	22	ns
		$V_{CC} = 6.0 V$		-	6	13	-	16	-	19	ns

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Symbol	Parameter	Conditions		T _{an}	_{nb} = 25	°C		= –40 °C ⋅85 °C		-40 °C 25 °C	Unit
				Min	Тур	Max	Min	Max	Min	Max	
C _{PD}	power dissipation capacitance	C_L = 50 pF; f = 1 MHz; V _I = GND to V _{CC}	<u>[3]</u>	-	40	-	-	-	-	-	pF
74HCT1	51-Q100										
t _{pd}	propagation	In to Y; see Figure 5	[1]								
	delay	$V_{CC} = 4.5 V$		-	22	38	-	48	-	57	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	19	-	-	-	-	-	ns
		In to \overline{Y} ; see Figure 5	[1]								
		$V_{CC} = 4.5 V$		-	22	38	-	48	-	57	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	19	-	-	-	-	-	ns
		Sn to Y; see Figure 6	<u>[1]</u>								
		$V_{CC} = 4.5 V$		-	23	41	-	51	-	62	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	20	-	-	-	-	-	ns
		Sn to \overline{Y} ; see Figure 6	<u>[1]</u>								
		$V_{CC} = 4.5 V$		-	25	43	-	54	-	65	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	20	-	-	-	-	-	ns
		E to Y; see Figure 6	<u>[1]</u>								
		$V_{CC} = 4.5 V$		-	16	29	-	36	-	44	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	13	-	-	-	-	-	ns
		\overline{E} to \overline{Y} ; see Figure 6	<u>[1]</u>								
		$V_{CC} = 4.5 V$		-	21	36	-	45	-	54	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	18	-	-	-	-	-	ns
t _t	transition	Y, \overline{Y} ; see Figure 5	[2]								
	time	$V_{CC} = 4.5 V$		-	7	15	-	19	-	22	ns
C _{PD}	power dissipation capacitance	$C_L = 50 \text{ pF}; \text{ f} = 1 \text{ MHz};$ V _I = GND to V _{CC}	<u>[3]</u>	-	40	-	-	-	-	-	pF

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 7

[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

 C_L = output load capacitance in pF;

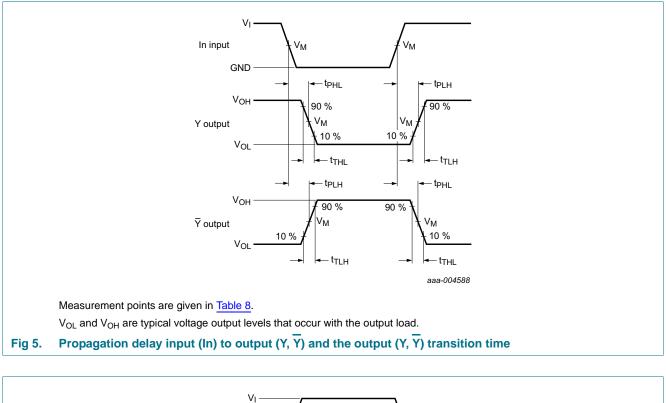
 V_{CC} = supply voltage in V;

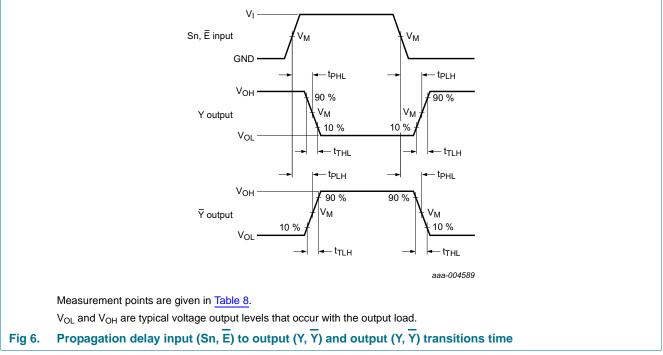
N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

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11. Waveforms





74HC_HCT151_Q100
Product data sheet

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Table 8. Measurement points		
Туре	Input	Output
	V _M	V _M
74HC151-Q100	0.5V _{CC}	0.5V _{CC}
74HCT151-Q100	1.3 V	1.3 V

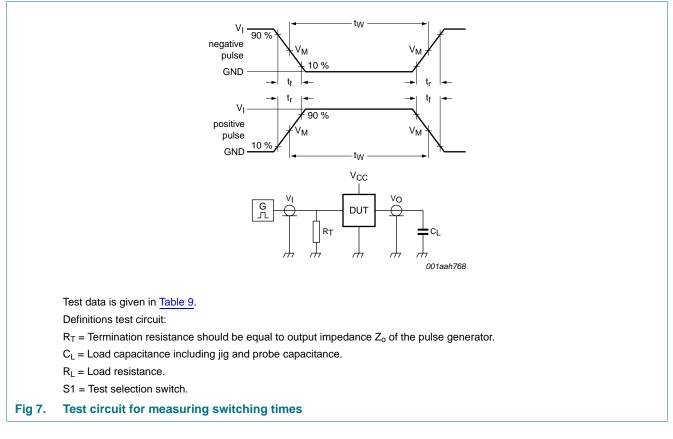


Table 9. Test data	l			
Туре	Input		Load	Test
	VI	t _r , t _f	CL	
74HC151-Q100	V _{CC}	6.0 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}
74HCT151-Q100	3.0 V	6.0 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}

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12. Package outline

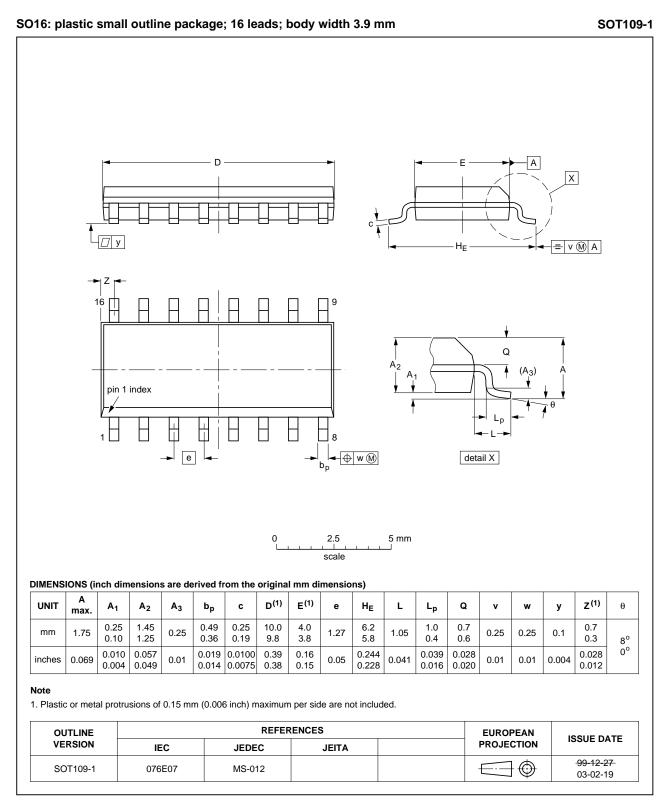


Fig 8. Package outline SOT109-1 (SO16)

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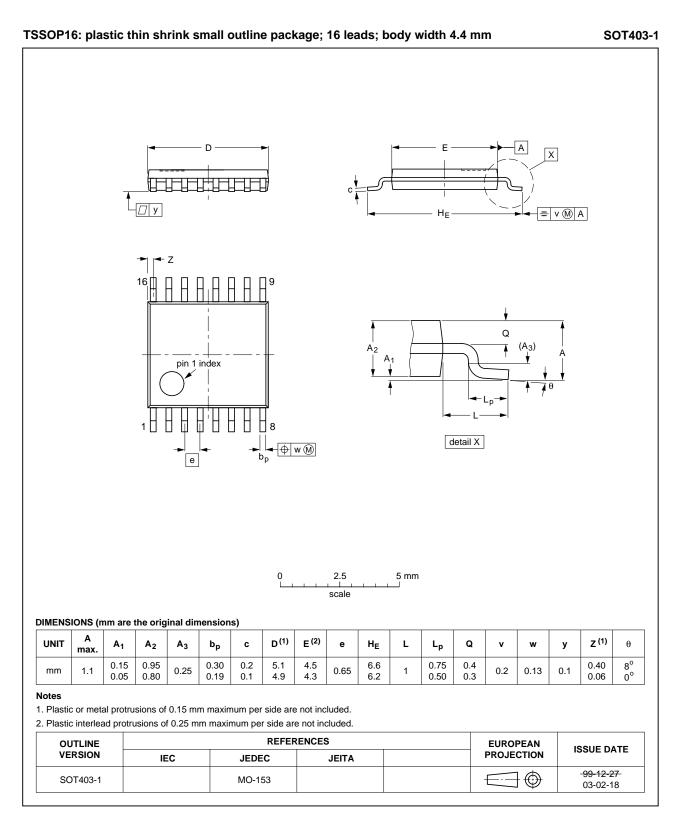


Fig 9. Package outline SOT403-1 (TSSOP16)

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74HC_HCT151_Q100

8-input multiplexer

13. Abbreviations

Acronym CMOS	Description
CMOS	
0000	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic
MIL	Military

14. Revision history

Table 11.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT151_Q100 v.2	20130211	Product data sheet	-	74HC_HCT151_Q100 v.1
Modifications: • New descriptive title (errata)				
74HC_HCT151_Q100 v.1	20120807	Product data sheet	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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8-input multiplexer

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